

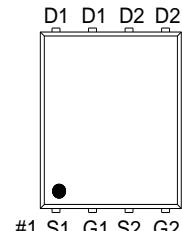
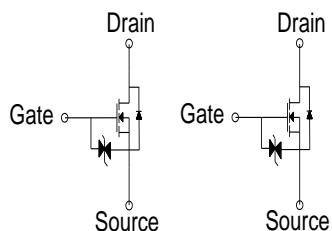
NIKO-SEM
**Dual N-Channel Enhancement Mode
Field Effect Transistor**
PZC010HK

PDFN 5x6P

Halogen-Free & Lead-Free

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
100V	295mΩ	4.7A

G. GATE
D. DRAIN
S. SOURCE**ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	± 16	V
Continuous Drain Current	$T_C = 25^\circ\text{C}$	I_D	4.7	A
	$T_C = 100^\circ\text{C}$		3	
Pulsed Drain Current ¹		I_{DM}	12	
Continuous Drain Current	$T_A = 25^\circ\text{C}$	I_D	2.1	A
	$T_A = 70^\circ\text{C}$		1.6	
Avalanche Current		I_{AS}	1.1	
Avalanche Energy	$L = 1\text{mH}$	E_{AS}	0.6	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$	P_D	16	W
	$T_C = 100^\circ\text{C}$		6.4	
Power Dissipation ³	$T_A = 25^\circ\text{C}$	P_D	3.1	W
	$T_A = 70^\circ\text{C}$		2	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE MAXIMUM RATINGS

THERMAL RESISTANCE		SYMBOL	Value	UNITS
Junction-to-Ambient ²	$t \leq 10\text{s}$	$R_{\theta JA}$	40	°C / W
Junction-to-Ambient ²	Steady-State	$R_{\theta JA}$	70	
Junction-to-Case	Steady-State	$R_{\theta JC}$	7.8	

¹Pulse width limited by maximum junction temperature.²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.³The Power dissipation is based on $R_{\theta JA}$ $t \leq 10\text{s}$ value.

NIKO-SEM
**Dual N-Channel Enhancement Mode
Field Effect Transistor**
PZC010HK

PDFN 5x6P

Halogen-Free & Lead-Free

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	100			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1.3	1.8	2.3	
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 16\text{V}$			± 30	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 80\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
		$V_{\text{DS}} = 80\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 55^\circ\text{C}$			10	
Drain-Source On-State Resistance ¹	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 4.5\text{V}, I_D = 1\text{A}$		234	330	$\text{m}\Omega$
		$V_{\text{GS}} = 10\text{V}, I_D = 1\text{A}$		219	295	
Forward Transconductance ¹	g_{fs}	$V_{\text{DS}} = 5\text{V}, I_D = 1\text{A}$		8		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 25\text{V}, f = 1\text{MHz}$		213		pF
Output Capacitance	C_{oss}			29		
Reverse Transfer Capacitance	C_{rss}			16		
Gate Resistance	R_g	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$		2.3		Ω
Total Gate Charge ²	Q_g	$V_{\text{GS}} = 10\text{V}$		6.3		nC
		$V_{\text{GS}} = 4.5\text{V}$		4.1		
Gate-Source Charge ²	Q_{gs}	$V_{\text{DS}} = 50\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 1\text{A}$		0.5		nC
Gate-Drain Charge ²	Q_{gd}			2.6		
Turn-On Delay Time ²	$t_{\text{d(on)}}$			7.5		
Rise Time ²	t_r			5.3		
Turn-Off Delay Time ²	$t_{\text{d(off)}}$	$I_D \geq 1\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 6\Omega$		17		nS
Fall Time ²	t_f			3		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ\text{C}$)						
Continuous Current	I_S				4.7	A
Forward Voltage ¹	V_{SD}	$I_F = 1\text{A}, V_{\text{GS}} = 0\text{V}$			1	V
Reverse Recovery Time	t_{rr}	$I_F = 1\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$		21		nS
Reverse Recovery Charge	Q_{rr}			14		nC

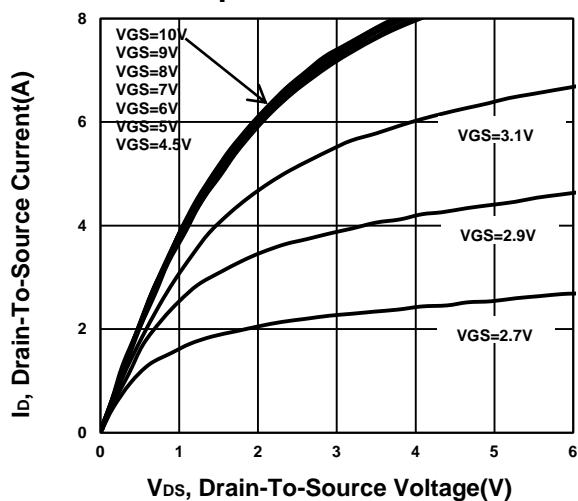
¹Pulse test : Pulse Width $\leq 300\ \mu\text{sec}$, Duty Cycle $\leq 2\%$.²Independent of operating temperature.

NIKO-SEM

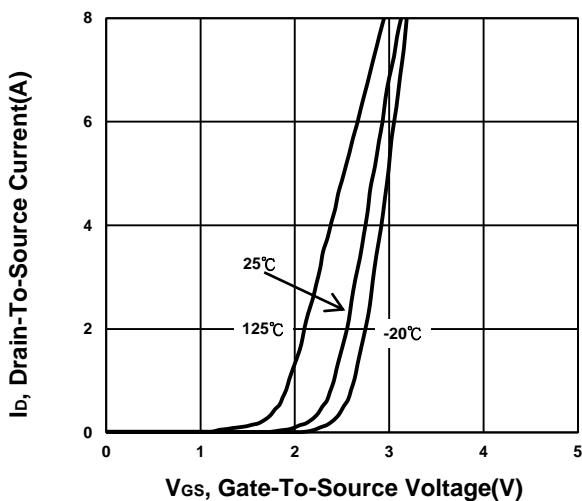
**Dual N-Channel Enhancement Mode
Field Effect Transistor**

PZC010HK
PDFN 5x6P
Halogen-Free & Lead-Free

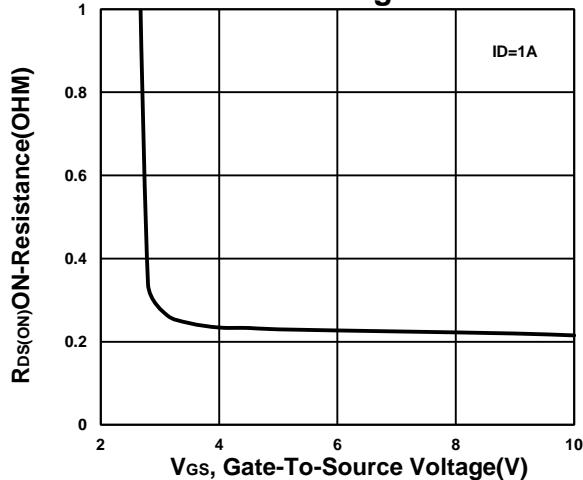
Output Characteristics



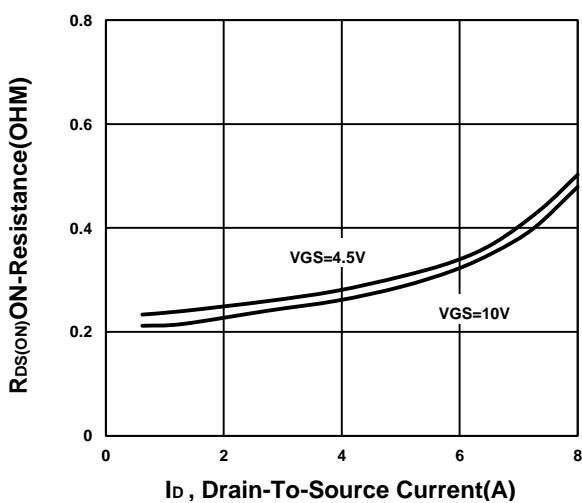
Transfer Characteristics



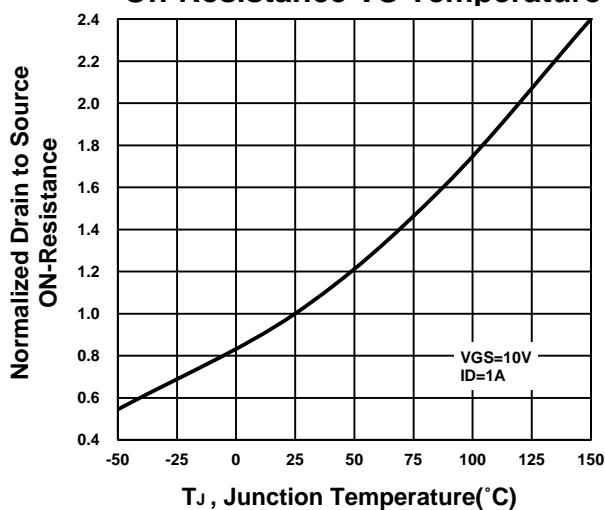
On-Resistance VS Gate-To-Source Voltage



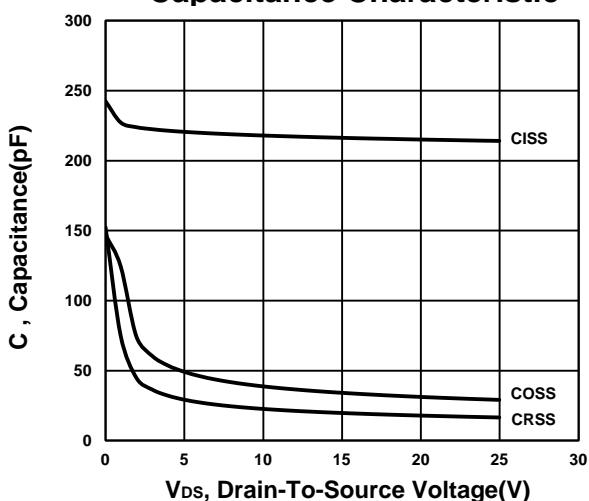
On-Resistance VS Drain Current



On-Resistance VS Temperature



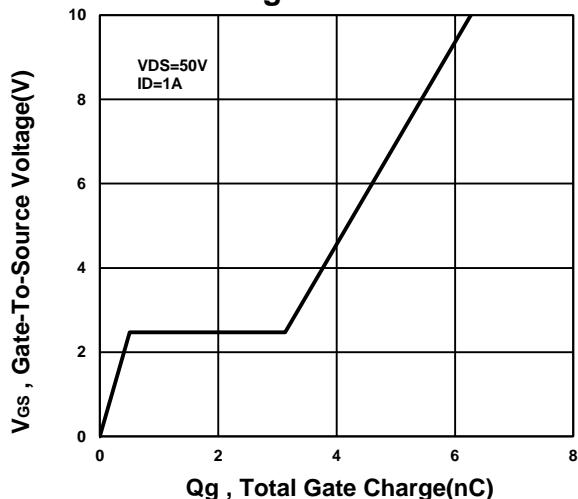
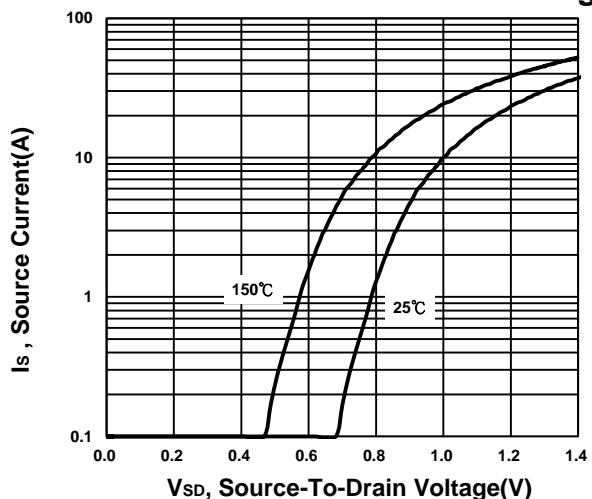
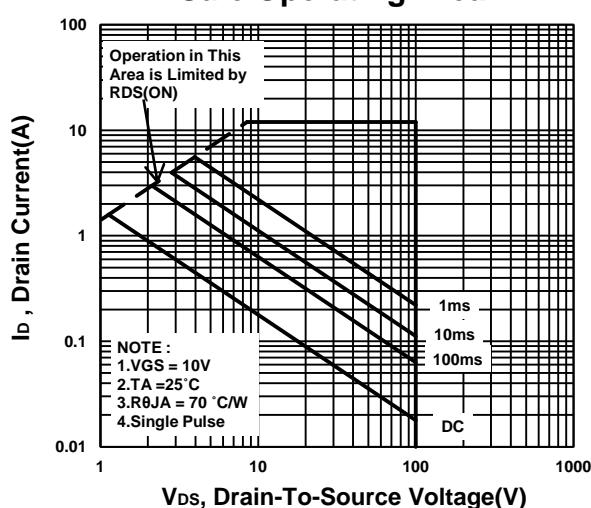
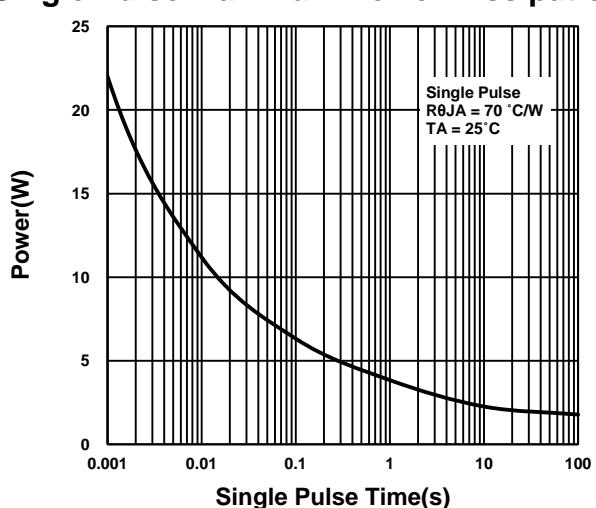
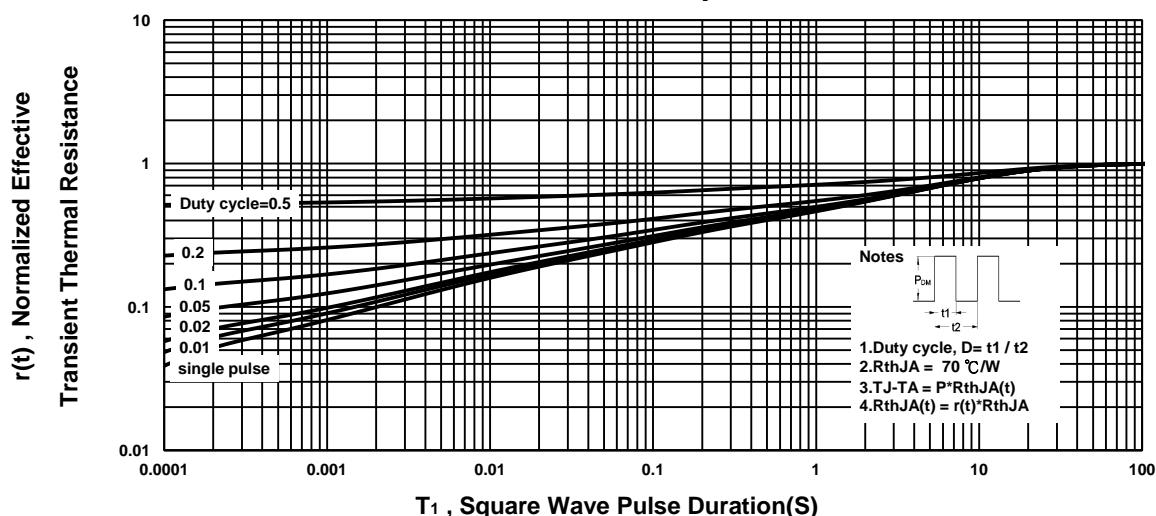
Capacitance Characteristic



NIKO-SEM**Dual N-Channel Enhancement Mode
Field Effect Transistor****PZC010HK**

PDFN 5x6P

Halogen-Free & Lead-Free

Gate charge Characteristics**Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**

NIKO-SEM

**Dual N-Channel Enhancement Mode
Field Effect Transistor**

PZC010HK

PDFN 5x6P

Halogen-Free & Lead-Free

